

S8KC THRU S8MC



Glass Passivated Silicon Rectifiers

Reverse Voltage: 800 to 1000 Volts

Forward Current: 8.0 Ampere

RoHS Device

Halogen Free

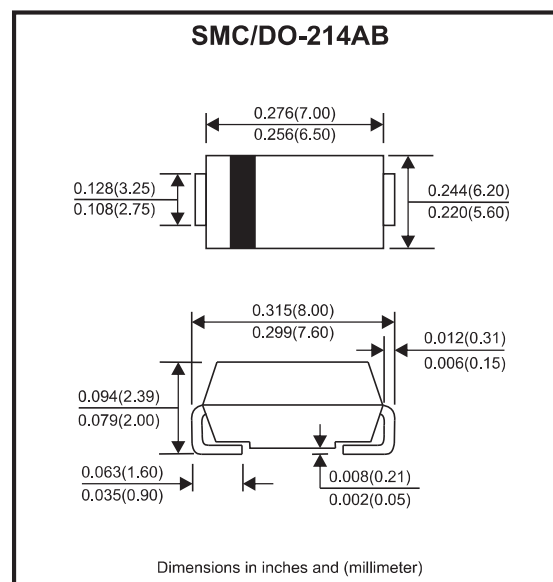


Features

- For surface mounted applications.
- Low profile package.
- Glass passivated chip junction.
- Easy to pick and place.

Mechanical data

- Case: SMC
- Terminals: Solderable per MIL-STD-750, method 2026.



Circuit Diagram



Maximum Ratings and Electrical Characteristics

Ratings at 25°C ambient temperature unless otherwise specified.

Single phase, half wave, 60Hz resistive or inductive load, for capacitive load, derate by 20%

Parameter	Symbols	S8KC	S8MC	Units
Maximum repetitive peak reverse voltage	V_{RRM}	800	1000	V
Maximum RMS voltage	V_{RMS}	560	700	V
Maximum DC blocking voltage	V_{DC}	800	1000	V
Maximum average forward rectified current	$I_{F(AV)}$	8		A
Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load	I_{FSM}	200		A
Max instantaneous forward voltage at 8A	V_F	0.985		V
Maximum DC reverse current $T_a = 25^{\circ}C$ at rated DC blocking voltage $T_a = 125^{\circ}C$	I_R	10 250		μA
Typical junction capacitance (Note 1)	C_j	40		pF
Typical thermal resistance (Note 2)	$R_{\theta JA}$ $R_{\theta JC}$	35 13		$^{\circ}C/W$
Operating and storage temperature range	T_j, T_{stg}	-55 ~ +150		$^{\circ}C$

Notes: 1. Measured at 1 MHz and applied reverse voltage of 4 V D.C

2. P.C.B. mounted with 2.0" X 2.0" (5 X 5 cm) copper pad areas.

Company reserves the right to improve product design , functions and reliability without notice.

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Rating and Characteristic Curves

Fig.1 - Forward Current Derating Curve

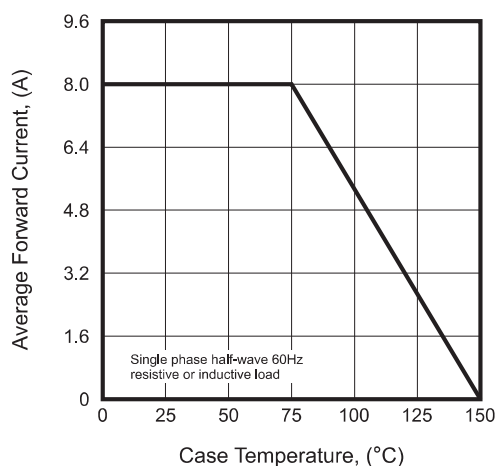


Fig.2 - Typical Reverse Characteristics

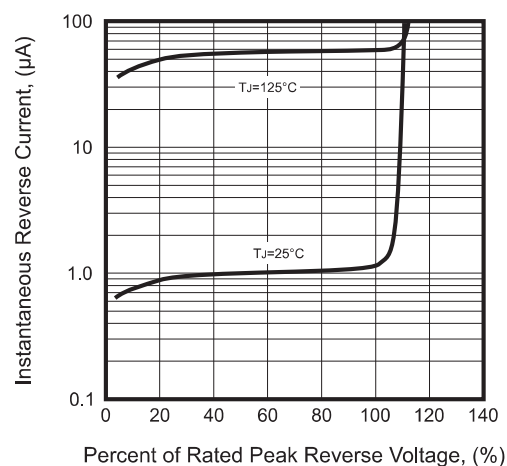


Fig.3 - Typical Forward Characteristic

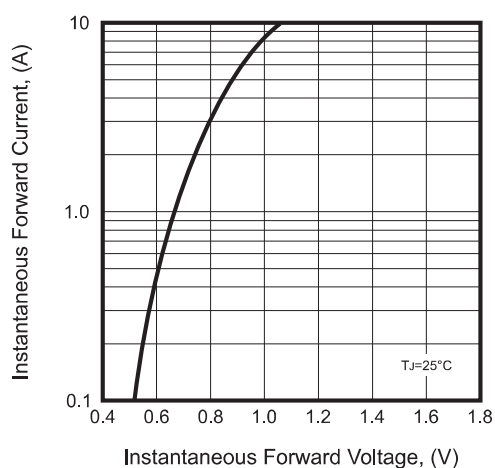


Fig.4 - Typical Junction Capacitance

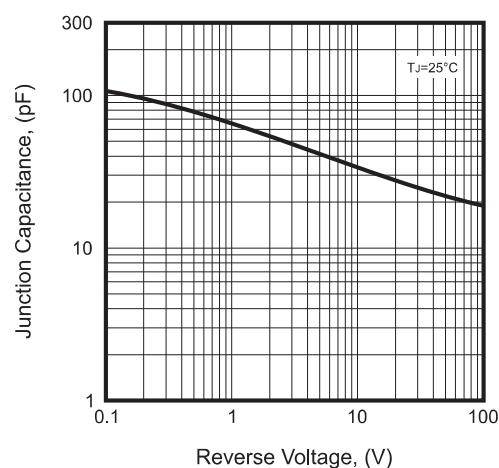
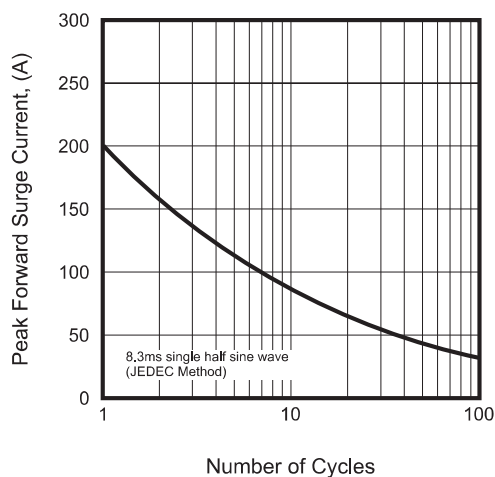
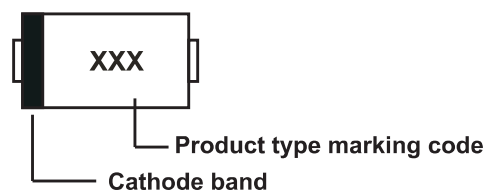


Fig.5 - Maximum Non-Repetitive Peak Forward Surge Current



Marking Code

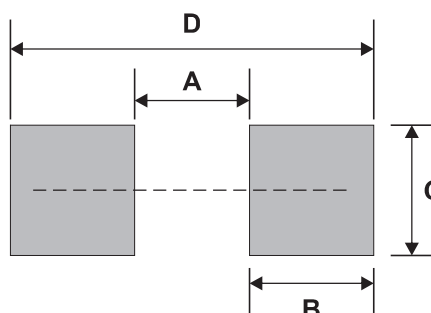
Part Number	Marking Code
S8KC	S8K
S8MC	S8M



xxx = Product type marking code

Suggested PAD Layout

SIZE	DO-214AB (SMC)	
	(mm)	(inch)
A	3.80	0.150
B	4.10	0.161
C	4.30	0.169
D	12.00	0.472

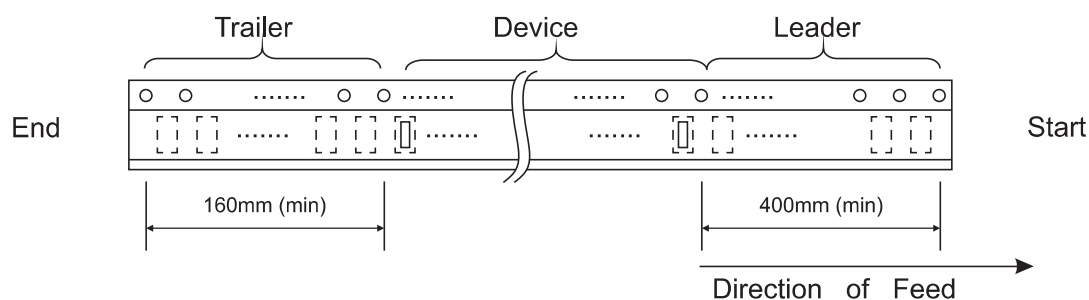
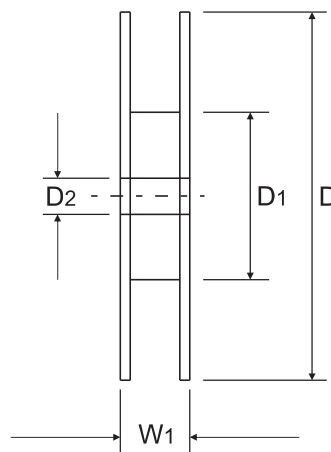
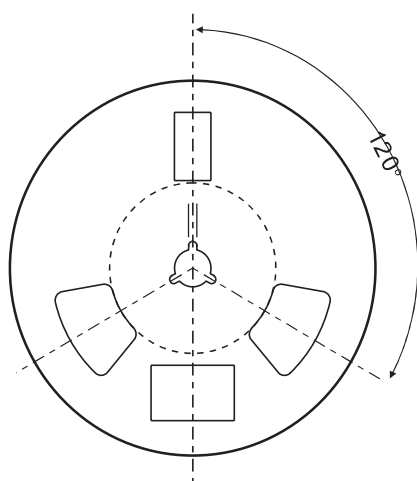
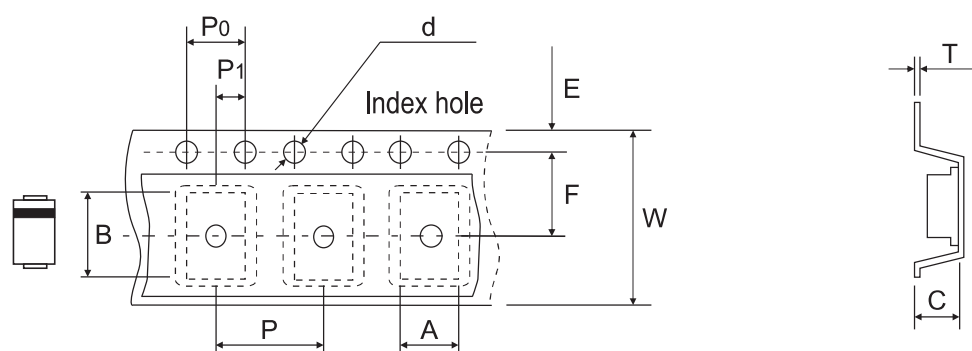


Note: 1. The pad layout is for reference purpose only.

Standard Packaging

Case Type	REEL PACK	
	REEL (pcs)	Reel Size (inch)
DO-214AB (SMC)	3,000	13

Reel Taping Specification



DO-214AB (SMC)	SYMBOL	A	B	C	d	D	D1	D2
	(mm)	6.22 ± 0.10	8.31 ± 0.10	2.49 ± 0.10	1.55 ± 0.05	330 ± 2.00	100.00 ± 1.00	13.00 ± 0.20
	(inch)	0.245 ± 0.004	0.327 ± 0.004	0.098 ± 0.004	0.061 ± 0.002	12.992 ± 0.079	3.937 ± 0.039	0.512 ± 0.008

DO-214AB (SMC)	SYMBOL	E	F	P	P0	P1	T	W	W1
	(mm)	1.75 ± 0.10	7.50 ± 0.10	8.00 ± 0.10	4.00 ± 0.10	2.00 ± 0.05	0.28 ± 0.02	16.00 ± 0.30	21.00 + 2.00 - 1.00
	(inch)	0.069 ± 0.004	0.295 ± 0.004	0.315 ± 0.004	0.157 ± 0.004	0.079 ± 0.002	0.011 ± 0.001	0.630 ± 0.012	0.827 + 0.079 - 0.039

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